

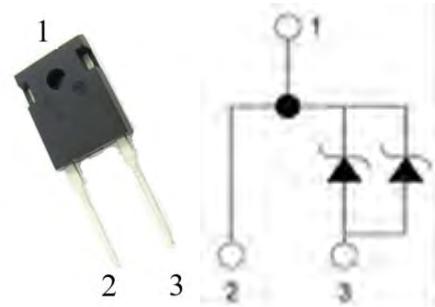


Features

- Zero Forward/Reverse Recovery Current
- High Blocking Voltage
- High Frequency Operation
- Positive Temperature Coefficient on V_F
- Temperature Independent Switching Behavior
- High surge current capability

$V_R = 1200 \text{ V}$
 $I_F = 40 \text{ A} (\text{T}_C=150^\circ\text{C})$
 $Q_c = 205 \text{nC} (V_R=800\text{V})$

TO-247-2L



Benefits

- Higher System Efficiency
- Parallel Device Convenience without thermal runaway
- Higher Temperature Application
- No Switching loss
- Hard Switching & Higher Reliability
- Environmental Protection

Applications

- Motor Drives
- Solar / Wind Inverters
- AC/DC converters
- DC/DC converters
- Uninterruptable power supplies

Maximum Ratings ($\text{T}_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test conditions	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
Continuous Forward Current	I_F	$\text{T}_C=25^\circ\text{C}$ $\text{T}_C=135^\circ\text{C}$ $\text{T}_C=150^\circ\text{C}$	110 52 40	A
Non repetitive Forward Surge Current	I_{FSM}	$\text{T}_C = 25^\circ\text{C}, t_p=10 \text{ ms},$ Half Sine Pulse $\text{T}_C = 110^\circ\text{C}, t_p=10 \text{ ms},$ Half Sine Pulse	280 260	A
Repetitive peak Forward Surge Current	I_{FRM}	$\text{T}_C = 25^\circ\text{C}, t_p=10 \text{ ms},$ Freq = 0.1Hz, 100 cycles, Half Sine Pulse $\text{T}_C = 110^\circ\text{C}, t_p=10 \text{ ms},$ Freq = 0.1Hz, 100 cycles, Half Sine Pulse	260 240	A
Total power dissipation	P_D	$\text{T}_C=25^\circ\text{C}$ $\text{T}_C=110^\circ\text{C}$	577 250	W
Single Pulse Avalanche Energy	E_{AS}	$L=2\text{mH}, I_{AS}=17\text{A}$	289	mJ
Diode dv/dt ruggedness	dv/dt	$V_R = 0-1200\text{V}$	80	V/ns
Operating Junction Temperature	T_J		-55 to 175	°C
Storage Temperature	T_{STG}		-55 to 175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



LGE3D40120H
Silicon Carbide Schottky Diode



Electrical Characteristics

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
DC Blocking Voltage	V_{DC}	$T_J = 25^\circ C$	1200			V
Forward Voltage	V_F	$I_F = 40A, T_J = 25^\circ C$		1.45	1.75	V
		$I_F = 40A, T_J = 125^\circ C$		1.78		
		$I_F = 40A, T_J = 175^\circ C$		2.0		
Reverse Current	I_R	$V_R = 1200V, T_J = 25^\circ C$		3	150	μA
		$V_R = 1200V, T_J = 125^\circ C$		12		
		$V_R = 1200V, T_J = 175^\circ C$		46		
Total Capacitive Charge	Q_C	$V_R = 800V, T_J = 25^\circ C$		205		nC
Total Capacitance	C	$V_R = 1V, T_J = 25^\circ C,$ $Freq = 1MHz$		2420		pF
		$V_R = 400V, T_J = 25^\circ C,$ $Freq = 1MHz$		194		
		$V_R = 800V, T_J = 25^\circ C,$ $Freq = 1MHz$		135		

Note: This is a majority carrier diode, so there is no reverse recovery charge

Thermal Characteristics

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Thermal Resistance	$R_{th(j-c)}$	junction-case		0.26		$^{\circ}C/W$



Typical Electrical Curves

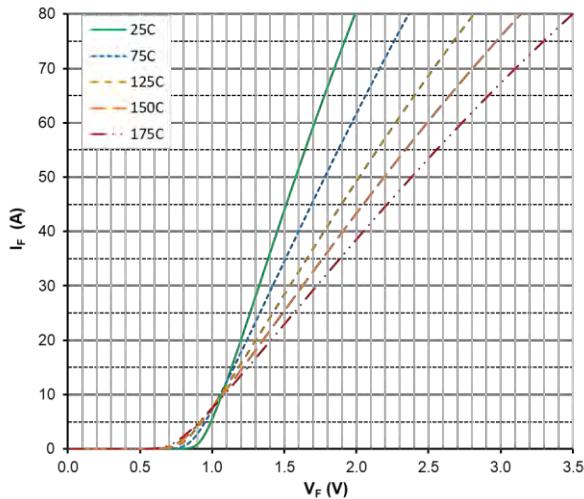


Figure 1. Forward Characteristics

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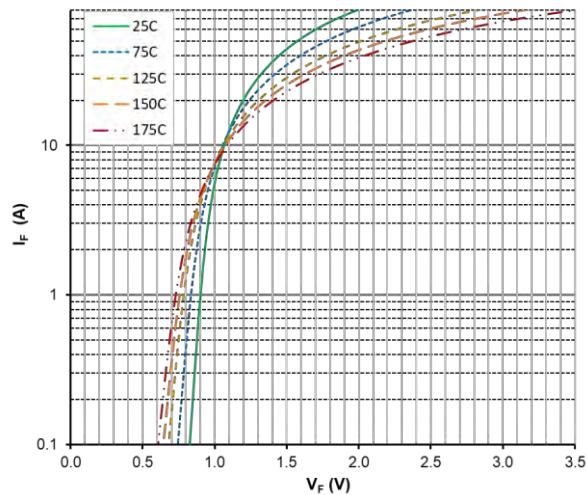


Figure 2. Forward Characteristics

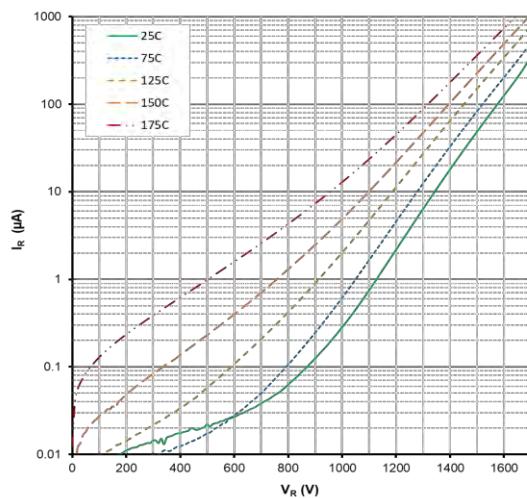


Figure 3. Reverse Characteristics

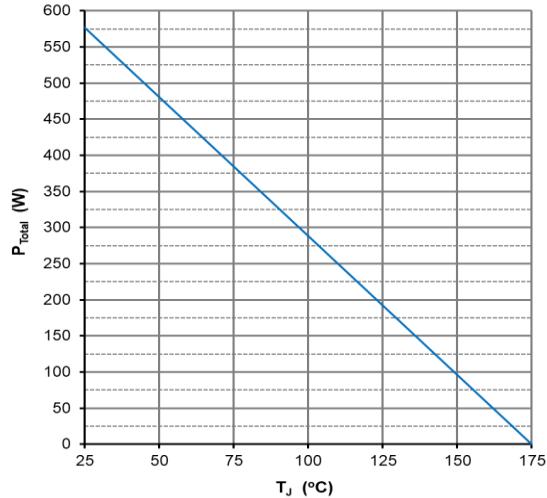


Figure 4. Power Derating

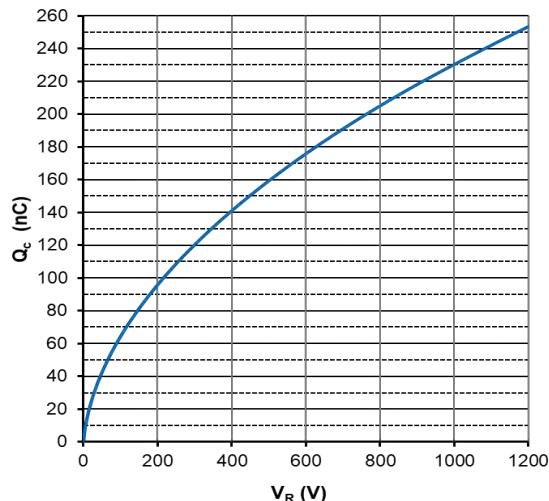


Figure 5. Reverse charge vs. Reverse Voltage

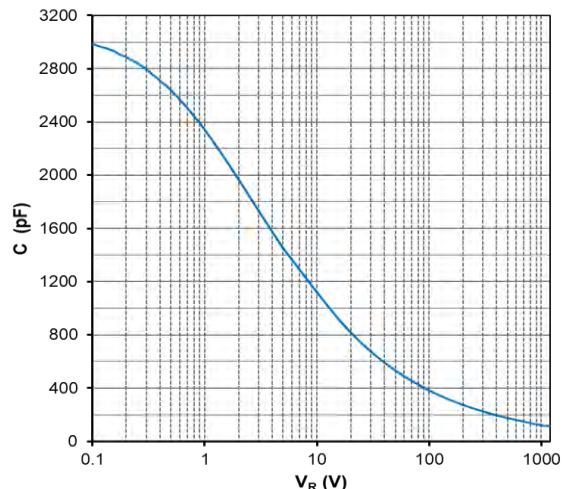
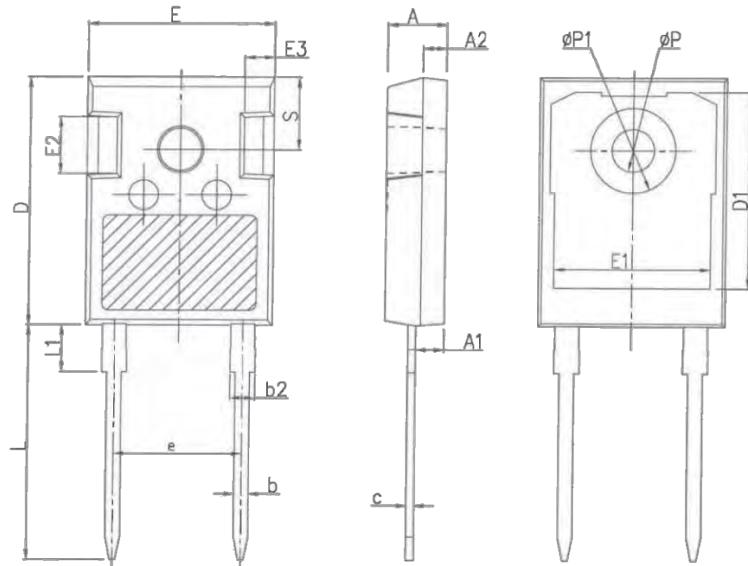


Figure 6. Capacitance vs. Reverse Voltage



Package Dimensions

(TO-247L-2 Package)



SYMBOL	mm	
	MIN.	MAX
A	4.8	5.20
A1	2.21	2.59
A2	1.85	2.15
b	1.11	1.36
b2	1.91	2.21
c	0.51	0.75
D	20.70	21.30
D1	16.25	16.85
E	15.50	16.10
E1	13.00	13.60
E2	4.80	5.20
E3	2.30	2.70
e	10.88BSC	
L	19.62	20.22
L1	-	4.30
φP	3.4	3.80
φP1	-	7.30
S	6.15BSC	

Packge	Packing	Box Size L×W×H(mm)	Quatity(pcs/box)	Carton Size L×W×H(mm)	Quatity(pcs/carton)
TO-247-2L	30pcs/Tube	570×155×50	450	580×340×125	1800